

FTR-C1 SERIES

■ SPECIFICATION

Item		Non-latching FTR-C1 () A	Latching FTR-C1 () B
Contact Data	Configuration	2 form C	
	Construction	Bifurcated	
	Material	Gold plated silver palladium (stationary contact) Silver palladium (movable contact)	
	Resistance (Initial)	Max. 150mΩ at 1A, 6VDC	
	Contact rating resistive	1A, 30VDC / 0.3A, 125VAC	
	Max. Switching Voltage	250VAC / 220VDC	
	Max. Switching Power	62.5VA / 30W	
	Max. Carry Current	2A	
	Min. Switching Load *	0.01mA, 10mVDC	
Life	Mechanical	Min. 10 x 10 ⁶ operations	
	Electrical (resistive)	Min. 100 x 10 ³ operations at 0.3A, 125VAC / 1A, 30VD	
Coil Data	Rated Power	280 to 300mW	140 to 180mW
	Operate Power	158 to 162mW	158 to 162mW
	Pulse width	-	Min. 20ms
	Operating temp range	-40°C to +85°C (no frost)	
	Storage temperature / humidity	-40°C to +85°C / 5% to 85% RH (no frost)	
Timing Data	Operate (at nominal voltage)	Max. 6ms (without bounce)	
	Release (at nominal voltage)	Max. 6ms (without bounce)	
Insulation	Resistance (Initial)		Min. 1,000MΩ at 500VDC
	Dielectric strength	Open contacts	1,500VAC (50/60Hz) 1min
		Adjacent contacts	1,500VAC (50/60Hz) 1min
		Contacts to coil	3,000VAC (50/60Hz) 1min
	Surge strength	Contacts to coil	5,000V, 2 x 10μs
	Clearance	Open contacts	0.6mm
		Adjacent contacts	1.0mm
		Contacts to coil	2.0mm
	Creepage	Open contacts	0.6mm
		Adjacent contacts	1.0mm
		Contacts to coil	2.5mm
Other	Vibration Resistance	Misoperation>1us	10 to 55 to 10 Hz single amplitude 1.65mm
		Endurance	10 to 55 to 10 Hz single amplitude 2.5mm
	Shock	Misoperation>1us	Min. 500m/s ² (11+/-1ms)
		Endurance	Min. 1,000m/s ² (6+/-1ms)
	Weight		Approximately 2g
	Sealing		RT III (plastic sealed)

* Minimum switching loads mentioned above are reference values. Please perform the confirmation test with actual load before production since reference values may vary according to switching frequencies, environmental conditions and expected reliability levels.

■ COIL RATING

Standard type

Coil Code	Rated Coil Voltage (VDC)	Coil Resistance +/- 10% (Ohm)	Must Operate Voltage (VDC) *	Must Release Voltage (VDC) *	Nominal Coil Power (mW)
003	3	32.1	2.25	0.3	280
4.5	4.5	72.3	3.38	0.45	
005	5	89.3	3.75	0.5	
012	12	514	9	1.2	
024	24	1,920	18	2.4	300

Latching type

Coil Code	Rated Coil Voltage (VDC)	Coil Resistance +/- 10% (Ohm)	Set Voltage (VDC) *	Reset Voltage (VDC) *	Nominal Coil Power (mW)
003	3	64.0	+2.25	- 2.25	140
4.5	4.5	145	+3.38	- 3.38	
005	5	179	+3.75	- 3.75	
012	12	1,029	+9	- 9	
024	24	3,200	+18	- 18	180

Note: All values in the table are valid for 20°C and zero contact current.

* Specified operate values are valid for pulse wave voltage.

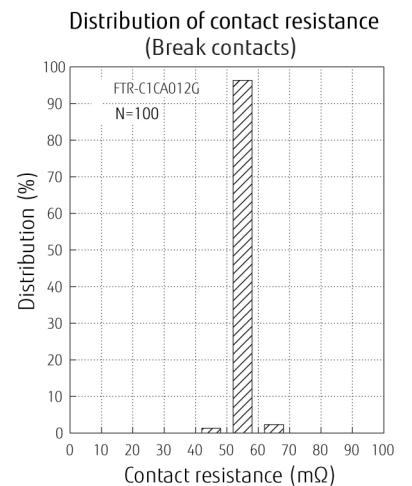
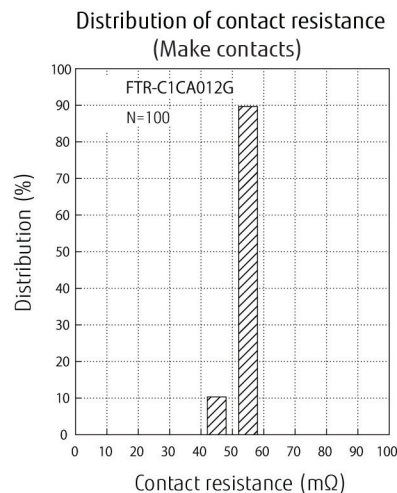
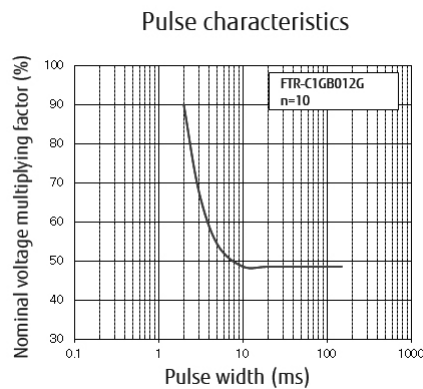
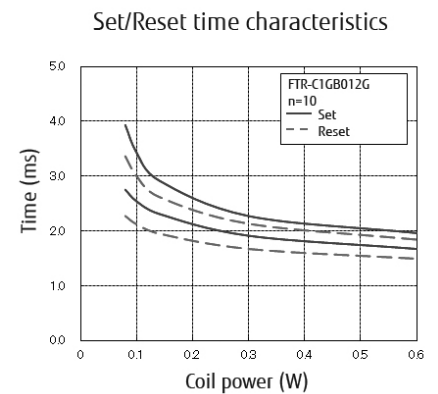
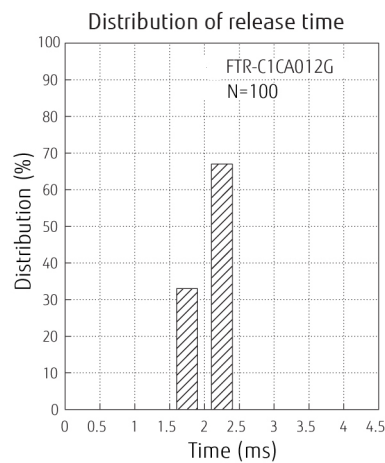
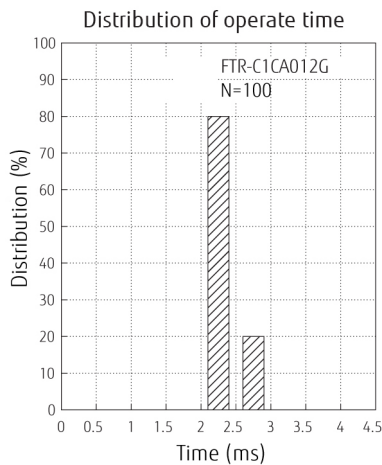
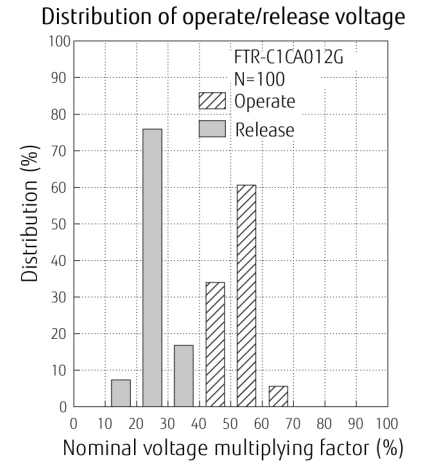
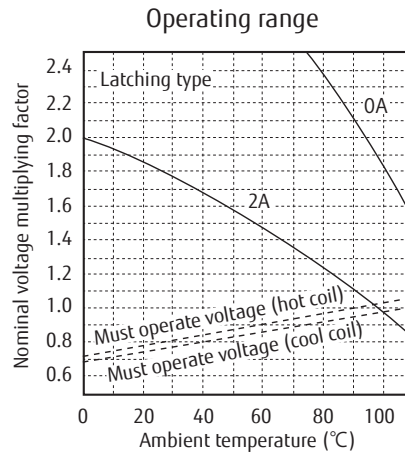
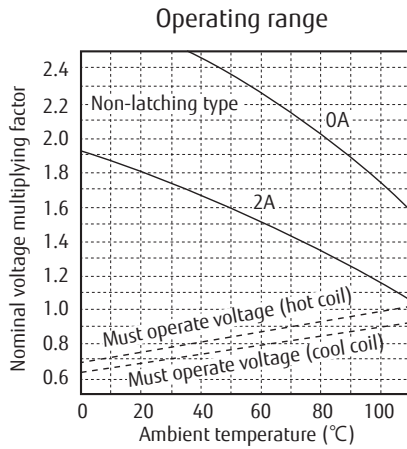
Note: Please use at rated coil voltage. Please perform the confirmation test with actual conditions.

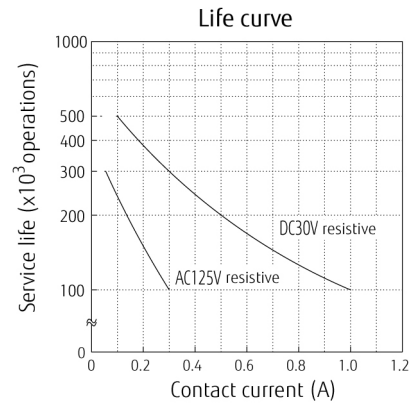
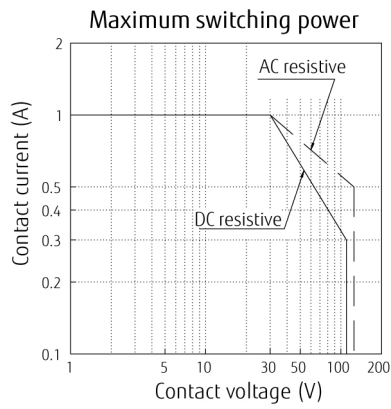
■ SAFETY STANDARDS

Type	Compliance	Contact rating
UL	UL 508	Flammability: UL 94-V0 (plastics)
	E63615	0.3A, 125 VAC (general use) (UL) 0.5A, 125VAC (CSA)
CSA	C22.2 No. 14 LR 40304	2A, 30VDC (general use) 0.3A, 110VDC (general use)

Comply with Telcordia specifications and meet BSI
Marking only for UL, CSA

■ CHARACTERISTIC DATA

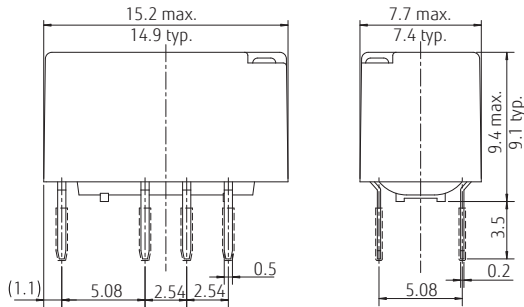




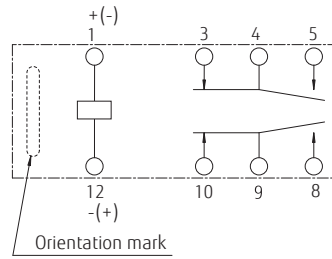
■ DIMENSIONS

Through hole type

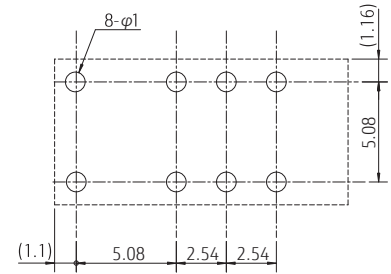
● Dimensions



● Schematics (BOTTOM VIEW)

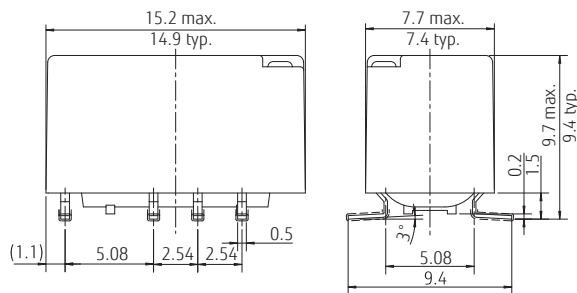


● Recommended PCB layout (BOTTOM VIEW)

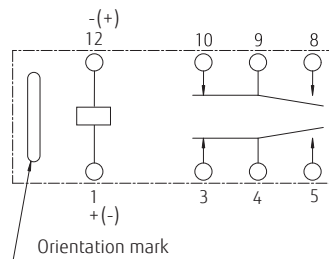


Surface mount type

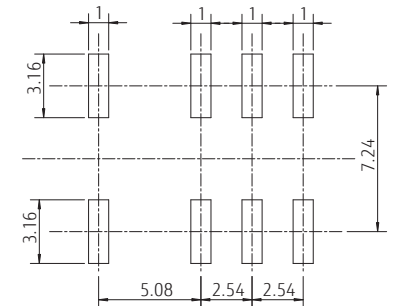
● Dimensions



● Schematics (TOP VIEW)

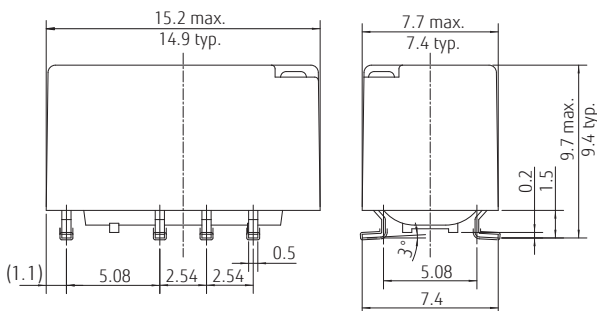


● Recommended PCB layout (TOP VIEW)

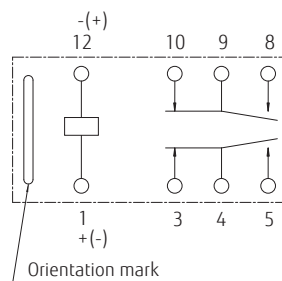


Surface mount (space saving) type

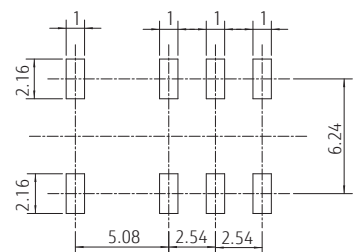
● Dimensions



● Schematics (TOP VIEW)



● Recommended PCB layout (TOP VIEW)



Note: (...) : dimensions are reference

Note: Dimensions of the terminals do not include thickness of pre-solder.

Note: Dimensions do not include tolerances. Please ask specification in case you need tolerances.

Note: Tolerance of PCB layout: ± 0.1 unless otherwise specified.

Unit: mm

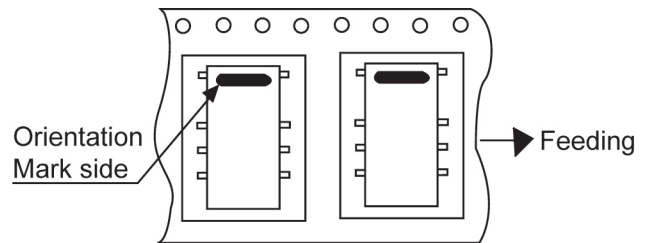
■ RECOMMENDED SOLDERING CONDITIONS SMT

(TEMPERATURE PROFILE, please see page 9)

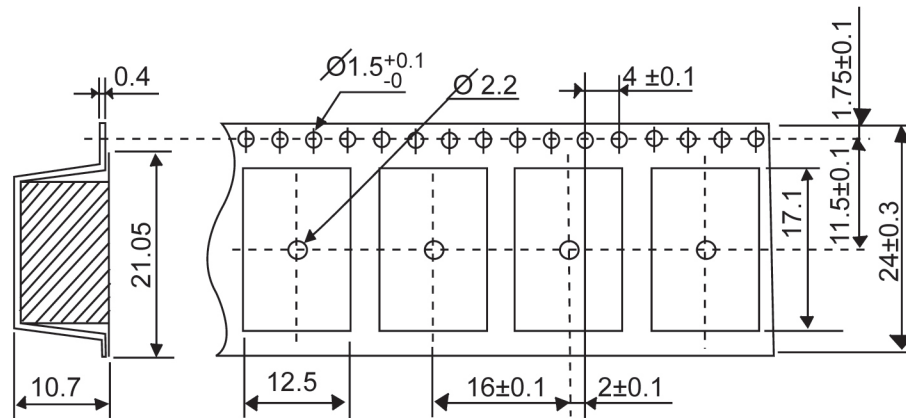
Note: 1. Temperature profiles show the temperature of PC board surface.
 2. Please perform soldering test with your actual PC board before mass production, since the temperatures of PC board surfaces vary according to the size of PC board, status of parts mounting and heating method.

■ TAPE & REEL PACKAGING SPECIFICATION

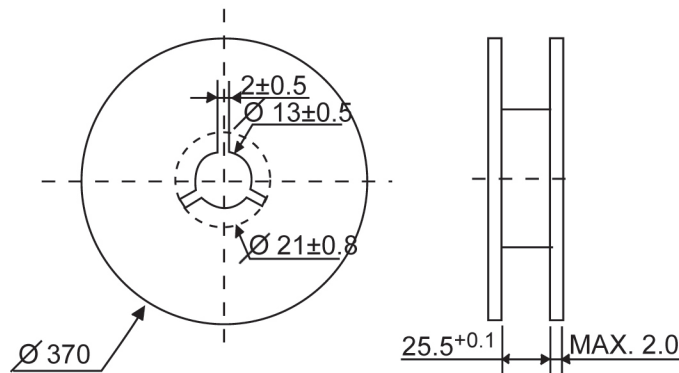
1. Taping standards: JIS C 0806 and RC-10092B (EIAJ)
2. Tape type: TB2416 or TE2416
3. Reel type: RD24D
4. Quantity of 1 reel: 500 pieces



Tape Dimensions:



Reel Dimensions:



Unit: mm

RoHS Compliance and Lead Free Information

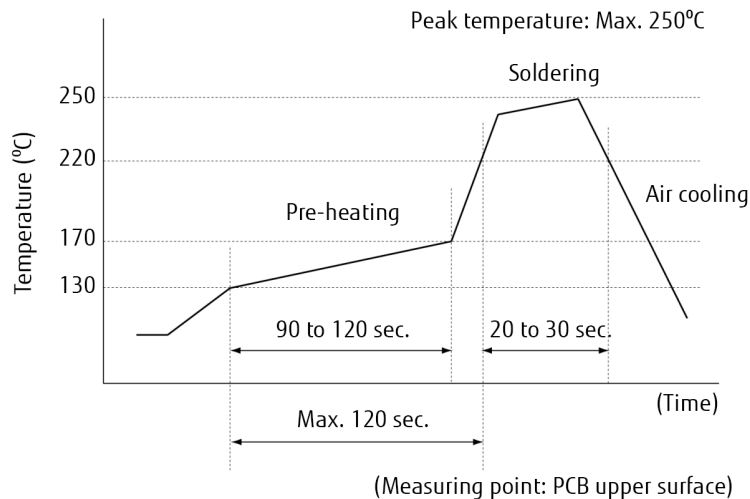
1. General Information

- All relays produced by Fujitsu Components are compliant with RoHS directive 2011/65/EU including amendments.
- Cadmium as used in electrical contacts is exempted from the RoHS directives.
As per Annex III of directive 2011/65/EU.
- All relays are lead-free. Please refer to Lead-Free Status Info for older date codes at:
<http://www.fujitsu.com/downloads/MICRO/fcai/relays/lead-free-letter.pdf>
- Lead free solder plating on relay terminals is Sn-3.0Ag-0.5Cu, unless otherwise specified.
This material has been verified to be compatible with PbSn assembly process.
- Characteristic data is not guaranteed values but measured values of samples from production line.

2. Recommended Lead Free Solder Condition

- Recommended solder Sn-3.0Ag-0.5Cu.

Reflow Solder condition for SMT



Flow Solder Condition:

Pre-heating: maximum 120°C within 90 sec.
Soldering: dip within 5 sec. at 255°C ± 5°C solder bath
Relay must be cooled by air immediately after soldering

Solder by Soldering Iron:

Soldering Iron 30-60W
Temperature: maximum 340-360°C
Duration: maximum 3 sec.

REFLOW

Note:

1. Temperature profiles show the temperature of PC board surface.
2. Please perform soldering test with your actual PC board before mass production, since the temperatures of PC board surfaces can vary, depending on the size of PC board, status of partsmounting and heating method.

We highly recommend that you confirm your actual solder conditions

3. Moisture Sensitivity

- SMT versions of FTR-C1 relays in Tape & Reel package will be shipped in Moisture Barrier Bag (MBB).
- Moisture Sensitivity Level (MSL) of FTR-C1 relay is indicated on the packing caution label.
- Relays must be stored in the unopened MBB at storage conditions <40°C/90%RH for a maximum 1 year
- SMT versions of FTR-C1 relays in tube packing will not be shipped in MBB. Therefore, these relays shall be dried by baking before reflow soldering process according to IPC/JEDEC J-STD-033.

4. Tin Whiskers

- Dipped SnAgCu solder is known as presenting a low risk to tin whisker development. No considerable length whisker was found by our in house test.

Cautions

- All values mentioned in this datasheet are provided under ideal conditions. Please perform the confirmation test before actual use.
- Do not use relays in the atmosphere with sulfide gas, chloride gas or nitric oxide. Contact resistance may increase.
- Do not use silicon or silicon-containing product or materials near relays. It may cause contact failure.

Notes for latching relay

- Latching relays are shipped in the state set, but state may change due to shock during transportation or mounting. Before using the relays, it is advisable to bring the relays in necessary state (set or reset) and program a circuit sequence. Otherwise, it will or will not operate simultaneously with power activation.
- Please connect relay coils according to specified polarity.
- Do not apply voltage to both set coil and reset coil at a time.

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